

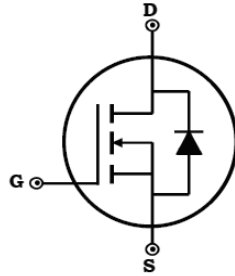


**N-Channel Enhancement Mode MOSFET**

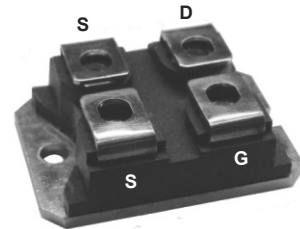
**Features**

- ◆  $V_{DS} = 100V$
- ◆  $R_{DS(ON)} < 1.1\ m\Omega @ V_{GS} = 10\ V$
- ◆ Fully Avalanche Rated
- ◆ Pb Free & RoHS Compliant
- ◆ Isolation Type Package
- ◆ Electrically Isolation base plate

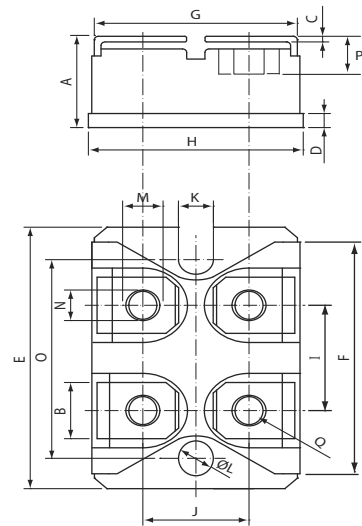
Preliminary



**SOT-227**



Dimensions in inches and (millimeters)



**Applications**

- ◆ Backlighting
- ◆ Power Converters
- ◆ Synchronous Rectifiers

**Absolute Maximum Ratings (Tc=25°C unless otherwise noted)**

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	$V_{DS}$	100	V
Gate-Source Voltage	$V_{GS}$	±20	V
Drain Current-Continuous @ $T_c = 25^\circ C$ @ $T_c = 100^\circ C$	$I_D$	560 445	A
Drain Current-Pulsed @ $T_c = 25^\circ C$ <sup>Note1</sup>	$I_{DM}$	1600	A
Maximum Power Dissipation	$P_D$	890	W
Storage Temperature Range	$T_{STG}$	-50 to +150	°C
Operating Junction Temperature Range	$T_J$	-50 to +150	°C
Thermal Resistance, Junction-to-Case	$R_{\theta_{JC}}$	0.10	°C/W
Isolation Voltage (A.C. 1 minute)	$V_{iso}$	2500	V
Mounting torque (M4 Screw)	$M_d$	1.3	Nm

DIM	DIMENSIONS			
	INCHES		MM	
	MIN	MXA	MIN	MXA
A	.500	.519	12.70	13.60
B	.307	.322	7.80	8.20
C	.029	.033	.75	.84
D	.073	.082	1.85	2.10
E	1.487	1.502	37.80	38.20
F	1.250	1.258	31.75	32.00
G	.931	.956	23.65	24.30
H	.996	1.007	25.30	25.60
I	.586	.594	14.90	15.10
J	.492	.516	12.50	13.10
K	.161	.169	4.10	4.30
L	.161	.169	4.10	4.30
M	.181	.191	4.60	4.95
N	.165	.177	4.20	4.50
O	1.184	1.192	30.10	30.30
P	.217	.244	5.50	6.20
Q	M4*8			



Electrical Characteristics @ T<sub>J</sub> =25°C (unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>OFF Characteristics</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V , I <sub>DS</sub> =3mA	100	-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> =0V , V <sub>DS</sub> =100V	-	-	50	uA
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>GS</sub> =±20V , V <sub>DS</sub> =0V	-	-	200	nA
<b>ON Characteristics</b>						
Gate Threshold Voltage	V <sub>TH</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>DS</sub> =8mA	2.5	-	3.5	V
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V , I <sub>DS</sub> =100A	-	1.0	1.1	mΩ
Gate Resistance	R <sub>G</sub>		-	1.9	2.9	Ω
Forward Transconductance	g <sub>fs</sub>	V <sub>DS</sub>   >2   I <sub>D</sub>   R <sub>DS(on)M</sub> , I <sub>D</sub> =100A <sup>Note1</sup>	-	127	-	S
<b>Dynamic Characteristics</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =25V	-	62520	-	pF
Output Capacitance	C <sub>oss</sub>	V <sub>GS</sub> =0V	-	2848	-	
Reverse Transfer Capacitance	C <sub>rss</sub>	Freq.=1MHz	-	2014	-	
<b>Switching Characteristics</b>						
Turn-On Delay Time	t <sub>d(on)</sub>	V <sub>DS</sub> =50V V <sub>GS</sub> =10V I <sub>DS</sub> =280A	-	164	-	ns
Rise Time	t <sub>r</sub>		-	68	-	
Turn-Off Delay Time	t <sub>d(off)</sub>		-	260	-	
Fall Time	t <sub>f</sub>		-	76	-	
Total Gate Charge at 10V	Q <sub>g</sub>	V <sub>DS</sub> =50V	-	449	-	nC
Gate to Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> =10V	-	307	-	
Gate to Drain Charge	Q <sub>gd</sub>	I <sub>DS</sub> =280A	-	221	-	
<b>Reverse Diode Characteristics</b>						
Drain-Source Diode Forward Voltage	V <sub>F</sub>	T <sub>J</sub> =25°C , I <sub>F</sub> =300A	-	-	1.0	V
Diode Continuous Forward Current	I <sub>F</sub>		-	-	445	A
Diode Pulsed Current <sup>Note1</sup>	I <sub>F,pulse</sub>		-	-	1600	A
Reverse Recovery time	T <sub>RR</sub>	I <sub>F</sub> =0.5V , I <sub>R</sub> =1.0A , I <sub>RR</sub> =0.25A	-	-	380	ns

Notes:

1. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle > 2%.



Typical Characteristics

Fig 1. Power dissipation

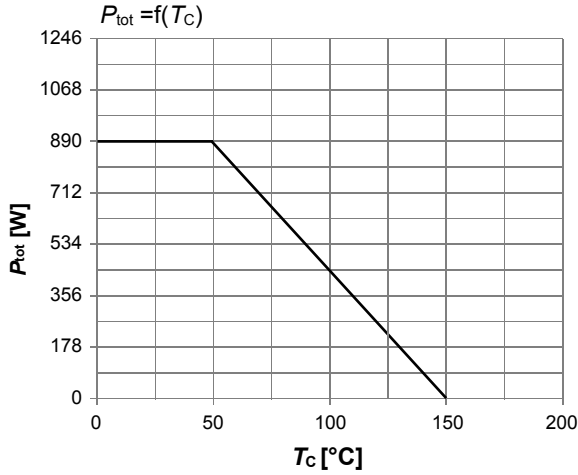


Fig 2. Drain current

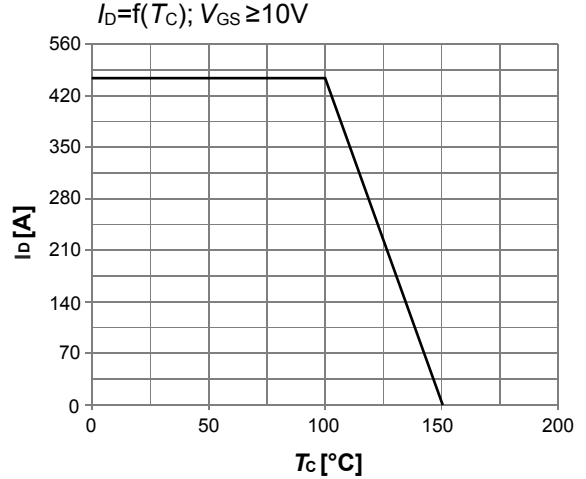


Fig 3. Safe operating area

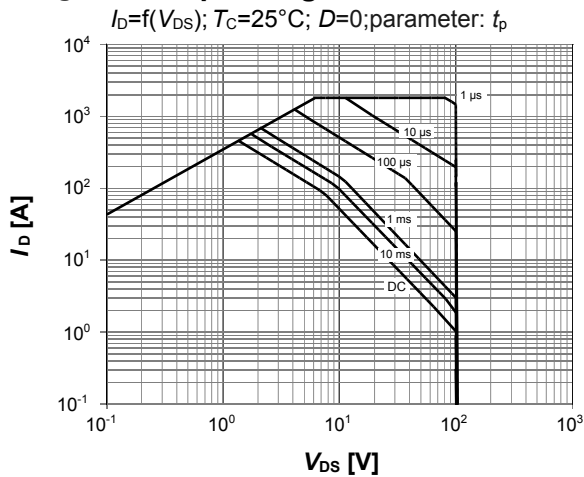


Fig 4. Maximum Transient Thermal Impedance

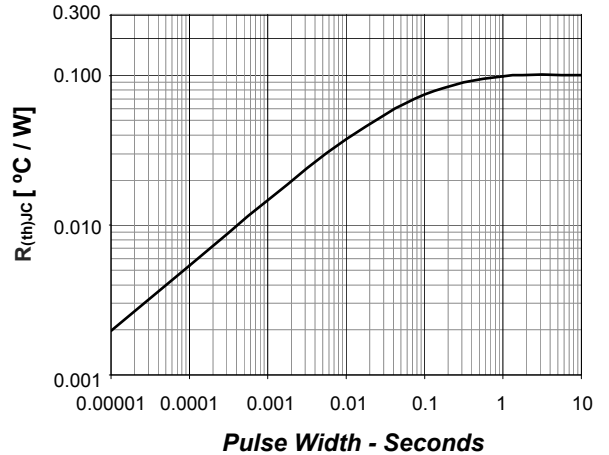


Fig 5. Typ. output characteristics

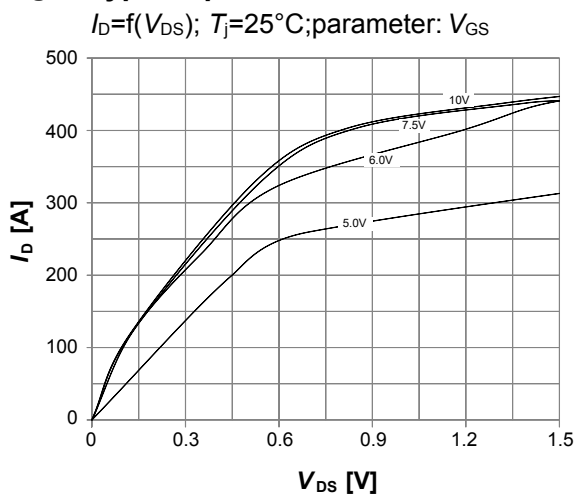
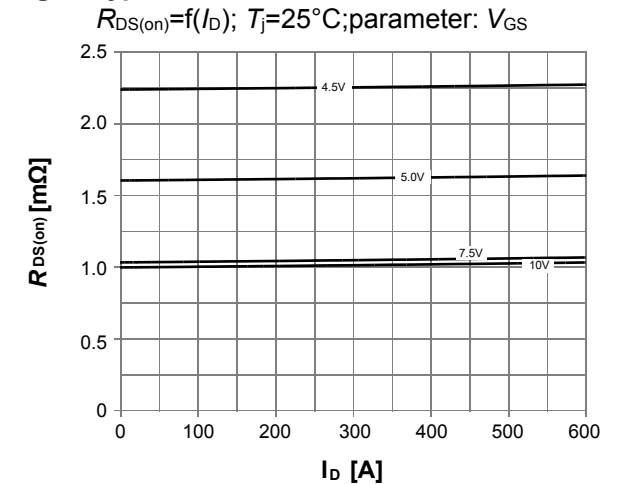


Fig 6. Typ. drain-source on resistance





Typical Characteristics

Fig 7. Typ. transfer characteristics

$I_D = f(V_{GS}); |V_{DS}| > 2|I_D|R_{DS(on)max}; \text{parameter: } T_j$

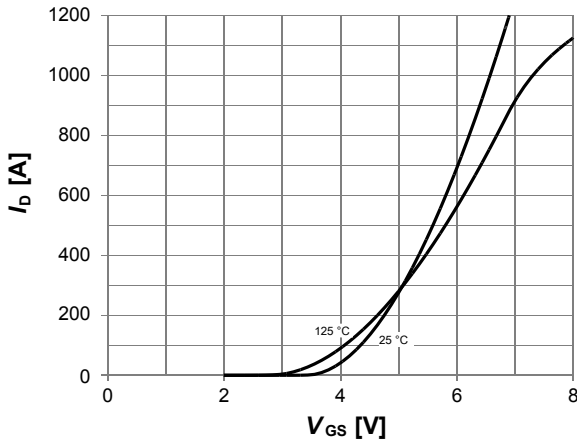


Fig 8. Typ. forward transconductance

$g_{fs} = f(I_D); T_j = 25^\circ\text{C}$

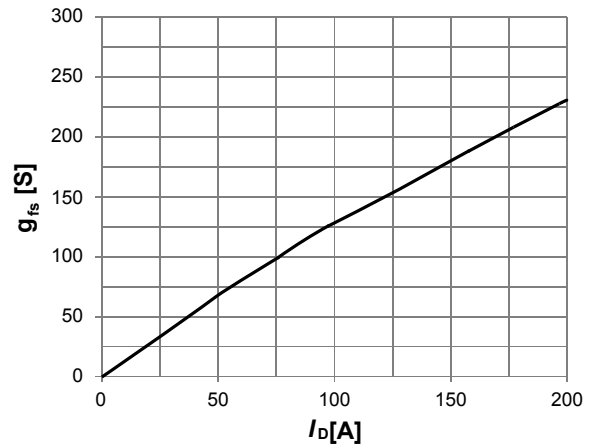


Fig 9. Drain-source on-state resistance

$R_{DS(on)} = f(T_j); I_D = 150\text{A}; V_{GS} = 10\text{V}$

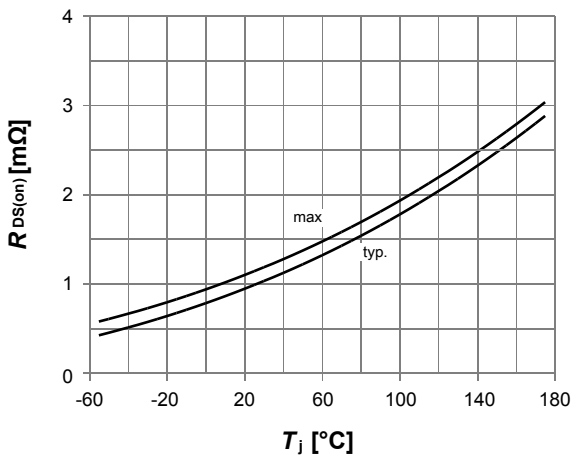


Fig 10. Typ. gate threshold voltage

$V_{GS(th)} = f(T_j); V_{GS} = V_{DS}; \text{parameter: } I_D$

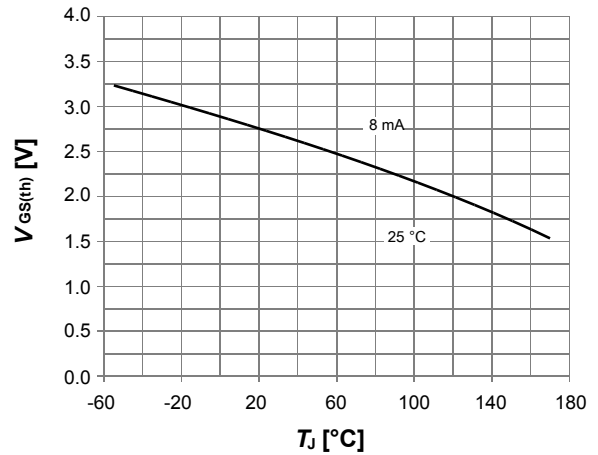


Fig 11. Typ. capacitances

$C = f(V_{DS}); V_{GS} = 0\text{V}; f = 1\text{MHz}$

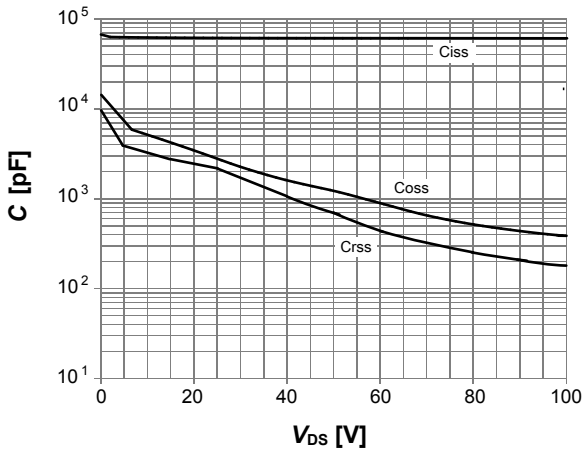
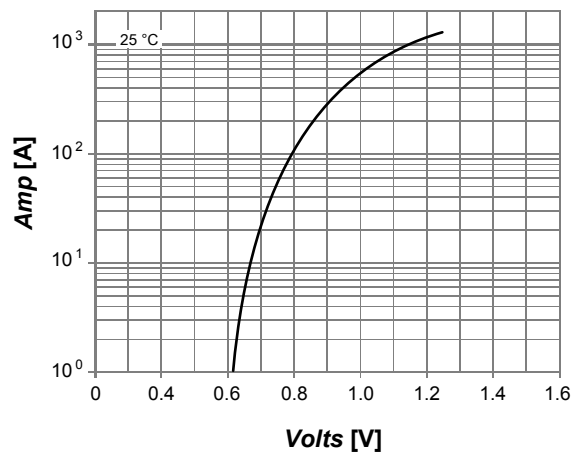


Fig 12. Typical forward characteristics of reverse diode





Typical Characteristics

Fig 13. Forward derating curve of reverse diode

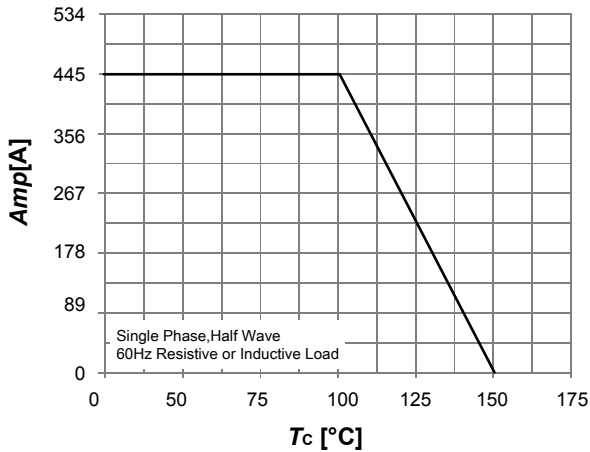


Fig 14. Peak forward surge current of reverse diode

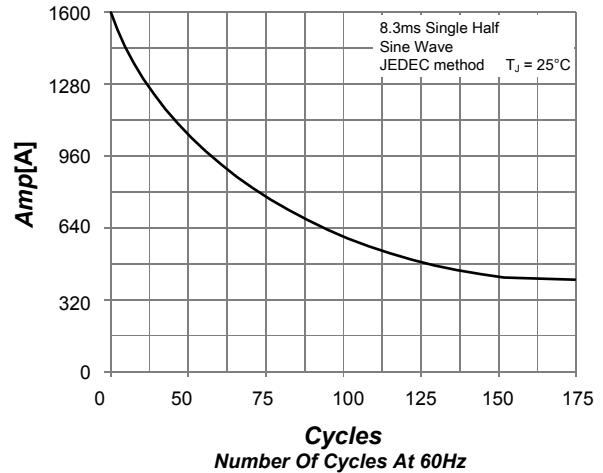


Fig 15. Typical reverse diode characteristics

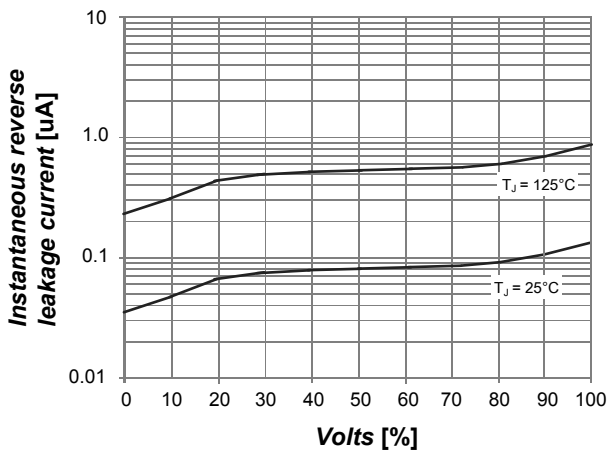


Fig 16. Typ. gate charge

$V_{GS}=f(Q_{gate})$ ;  $I_D=100A$  pulsed; parameter:  $V_{DD}$

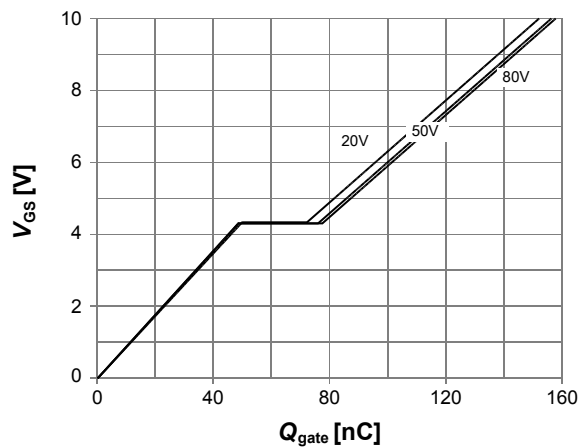
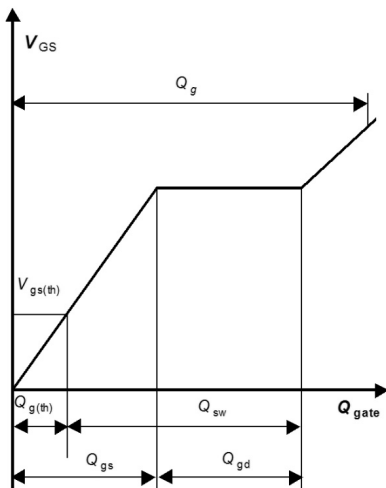


Fig 17. Gate charge waveforms



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